



CERAMIC

Bandpass Filter

BFHK-3142+

50Ω 28 to 36 GHz

THE BIG DEAL

- Ultra-High Stopband Rejection Structure – 75 dB typical
- Surface mountable pick and place standard case style
- Standard small 1812 (4.5mm x 3.2mm) case style
- High quality distributed filter topology
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (land grid array)
- Suited for very high-volume production
- Patent Pending



Generic photo used for illustration purposes only

CASE STYLE: NM1812C-3

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- Test and Measurement
- Aerospace and Defense Signal Conditioning

PRODUCT OVERVIEW

The BFHK-3142+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The passband loss at 28 – 36 GHz is as low as 2.8 dB, with typical stopband rejections at 75 dB up to 54 GHz and 40 dB up to 67 GHz. This model handles up to 1W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis.

KEY FEATURES

Feature	Advantages
Ultra-High Rejection	Typical stopband rejections at 75 dB up to 54 GHz and 40 dB up to 67 GHz
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (4.5mm x 3.2mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.

REV. A
 ECO-022343
 BFHK-3142+
 MCL NY
 240731





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ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	F#	Frequency (GHz)		Min.	Typ.	Max.	Units	
Center Frequency	—	—	—	—	31.7	—	GHz	
Pass Band	Insertion Loss	F1-F2	28	36	—	2.8	4.0	dB
	Return Loss	F1-F2	28	36	—	8.0	—	dB
Stop Band, Lower	Insertion Loss	DC-F3	0.1	20	70	85	—	dB
Stop Band, Upper	Insertion Loss	F4-F5	44	54	60	75	—	dB
			54	67	30	40	—	

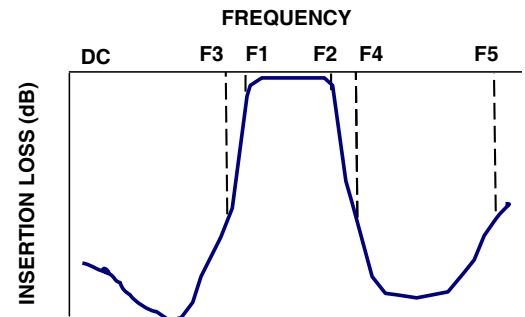
1. Measured on Mini-Circuits Test Board TB-BFHK-3142C+ with connectors and feedlines de-embedded.

MAXIMUM RATINGS

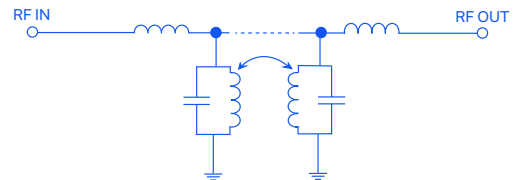
Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input	1W max.

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



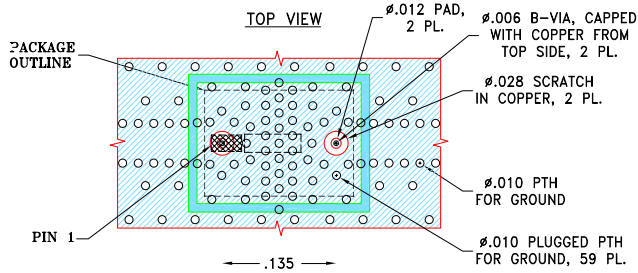


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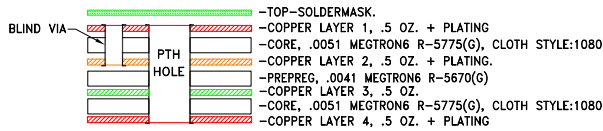
Bandpass Filter

BFHK-3142+

EVALUATION BOARD MCL P/N: TB-BFHK-3142C+ SUGGESTED PCB LAYOUT: PL-730



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS $0.0228 \pm .004$.
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED PLUGGED PTH'S ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. LAYER 4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

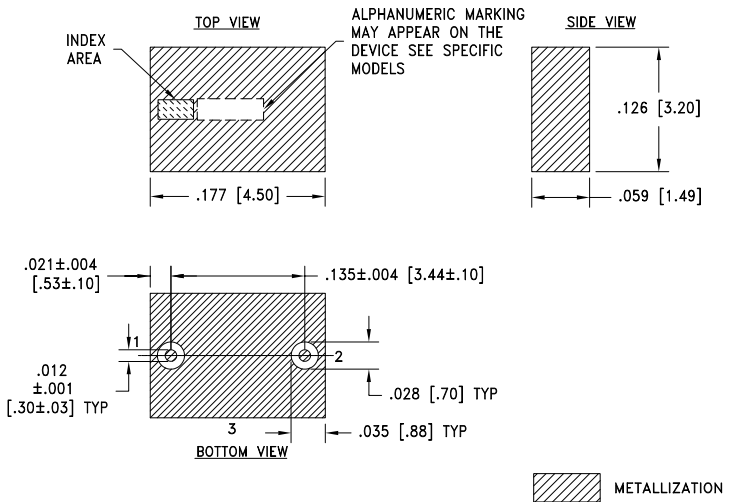
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

PAD CONNECTIONS

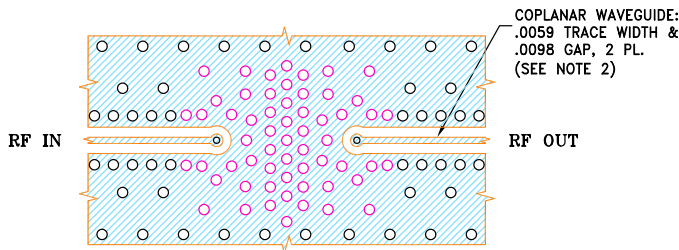
INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: F473

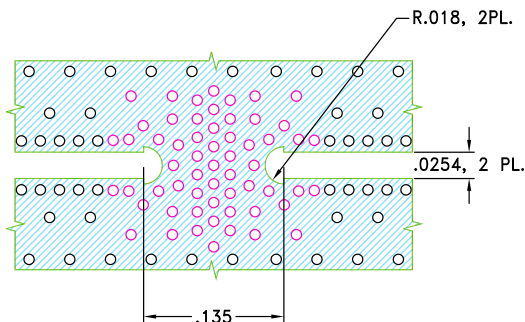
OUTLINE DRAWING



Weight: .126 grams.
Dimensions are in inches [mm]. Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$ Inches



LAYER 3 & PTH





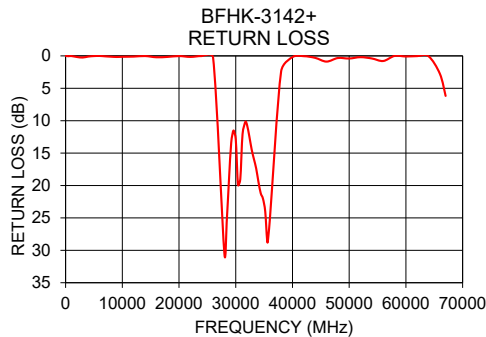
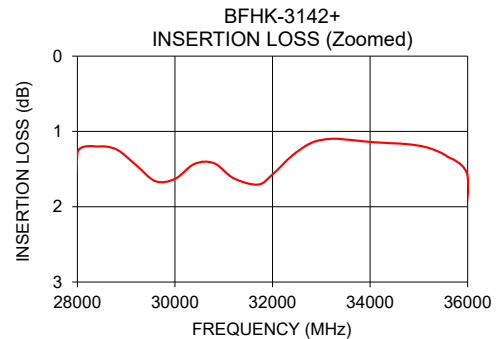
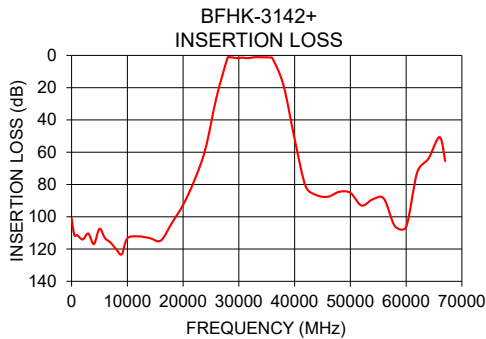
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BFHK-3142+

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
25	101.18	0.01
100	103.28	0.00
1000	111.44	0.02
2000	114.07	0.17
6000	113.29	0.01
8000	120.13	0.12
10000	113.38	0.14
12000	112.16	0.11
14000	113.19	0.02
16000	114.74	0.21
18000	103.80	0.15
20000	92.64	0.03
22000	77.66	0.16
24000	58.04	0.02
28000	1.29	30.54
31700	1.71	10.16
36000	1.60	25.39
44000	86.68	0.30
54000	89.22	0.40
67000	65.47	6.17



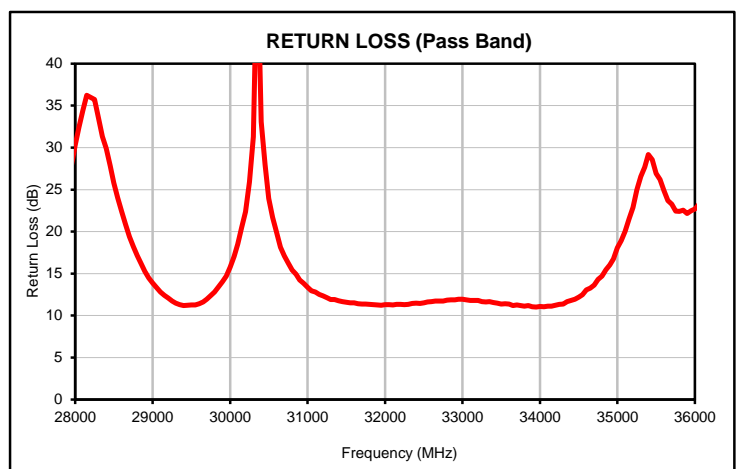
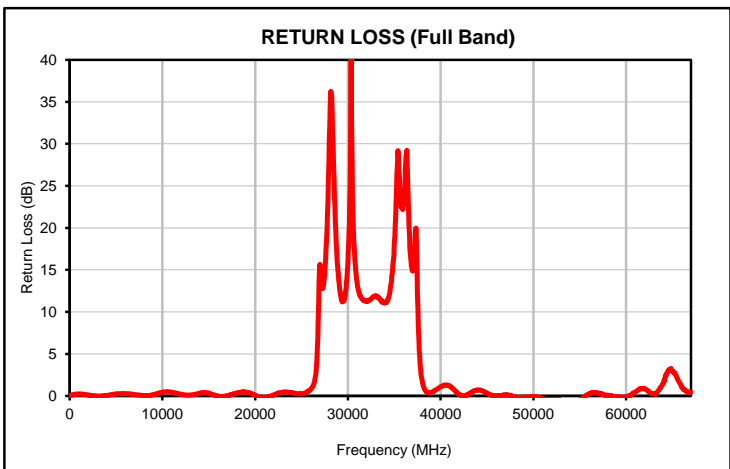
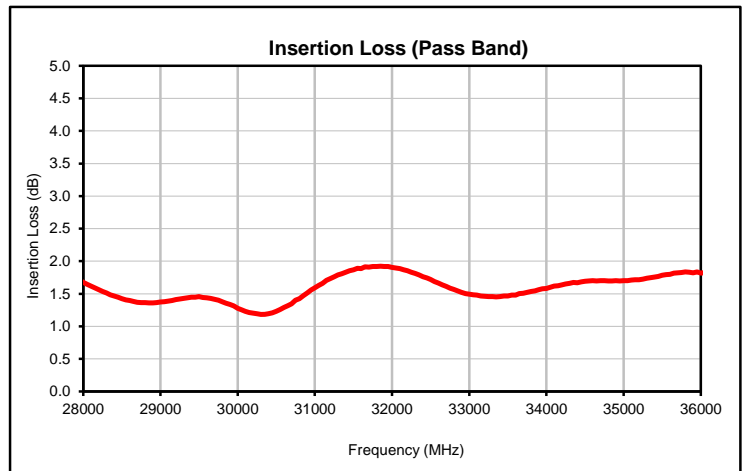
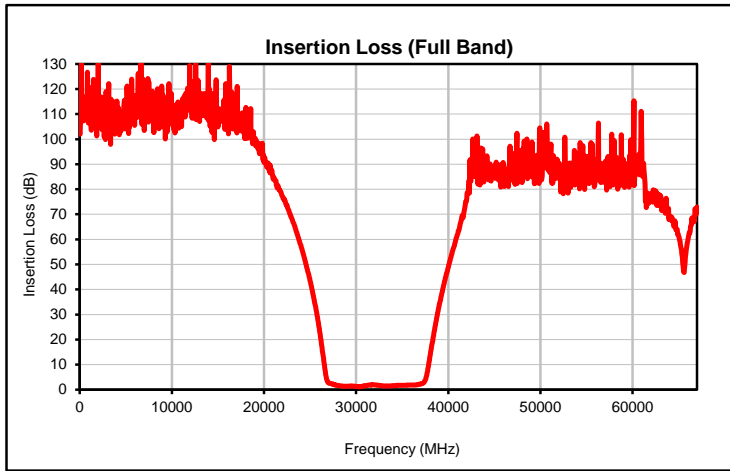
- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

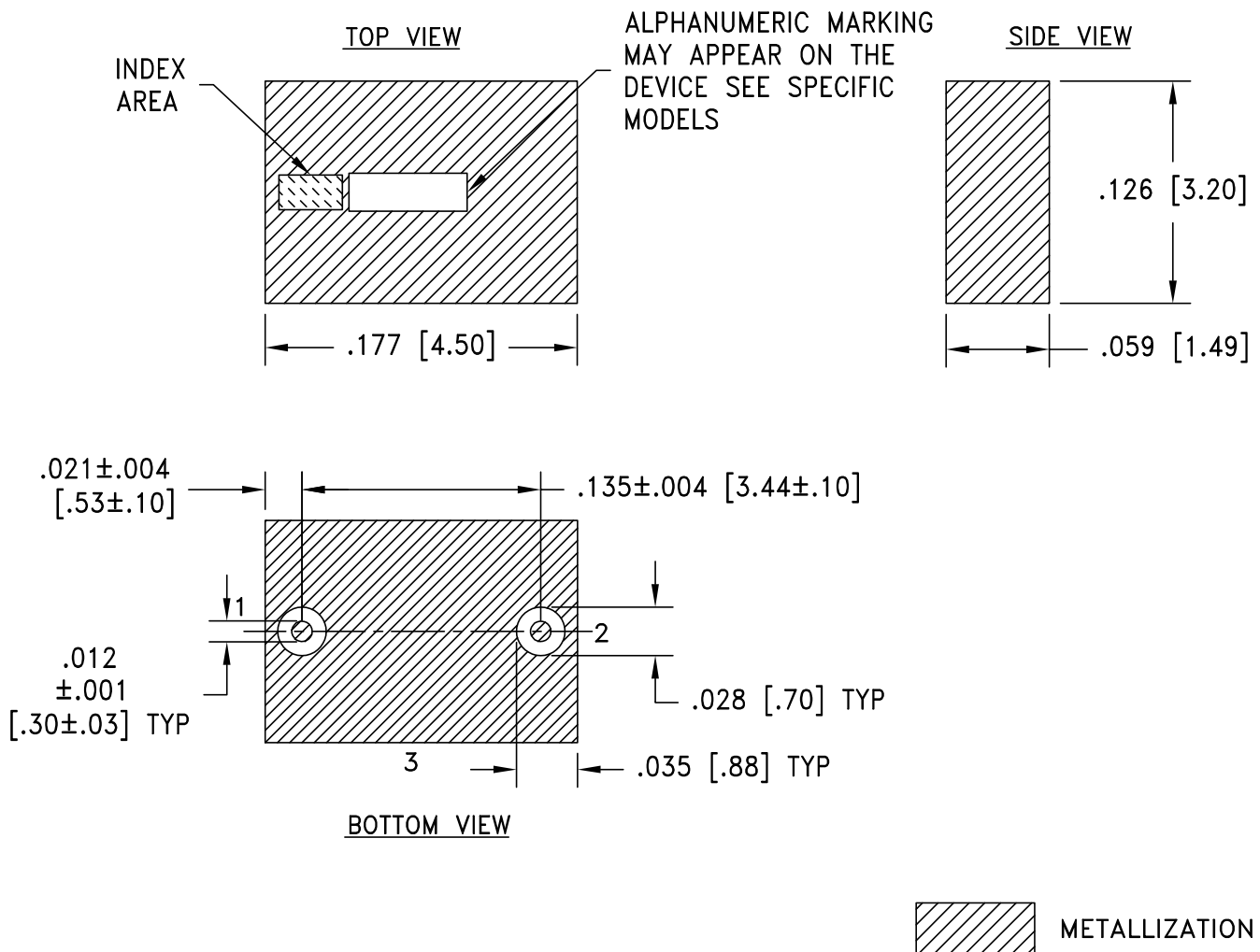


Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
100	107.61	0.07
500	113.00	0.19
1000	108.59	0.23
2000	130.32	0.10
4000	112.99	0.06
6000	116.33	0.27
8000	109.93	0.04
10000	107.25	0.43
12000	111.28	0.19
14000	107.52	0.31
16000	103.84	-0.02
18000	104.12	0.34
20000	90.65	0.08
22000	77.23	0.11
24000	57.52	0.37
26000	24.39	0.78
28000	1.67	30.37
28500	1.43	25.82
29000	1.37	13.89
29500	1.46	11.27
30000	1.27	15.80
30500	1.23	23.95
31000	1.59	13.39
31500	1.87	11.60
32000	1.90	11.30
32500	1.72	11.52
33000	1.49	11.95
33500	1.47	11.39
34000	1.58	11.08
34500	1.69	12.21
35000	1.70	18.09
35500	1.78	26.90
36000	1.82	22.69
37000	2.26	14.88
38000	12.84	1.81
39000	33.25	0.41
40000	48.93	1.09
41000	61.83	1.16
42000	75.95	0.14
43000	87.21	0.19
44000	86.29	0.72
45000	87.23	0.32
46000	89.24	-0.02
47000	88.63	0.12
48000	82.72	-0.13
49000	87.56	-0.26
50000	89.19	-0.10
52000	88.27	-0.54
54000	94.30	-0.89
56000	90.10	0.24
58000	99.49	0.07
60000	99.96	-0.15
62000	76.92	0.85
64000	69.01	1.53
66000	59.53	1.11
67000	72.94	0.46

Typical Performance Curves





Weight: .126 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$ Inches

Notes:

1. Case material: Ceramic.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin Plate over Nickel plate. All models, (+) suffix.

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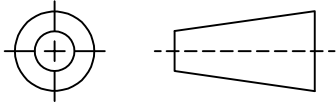
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

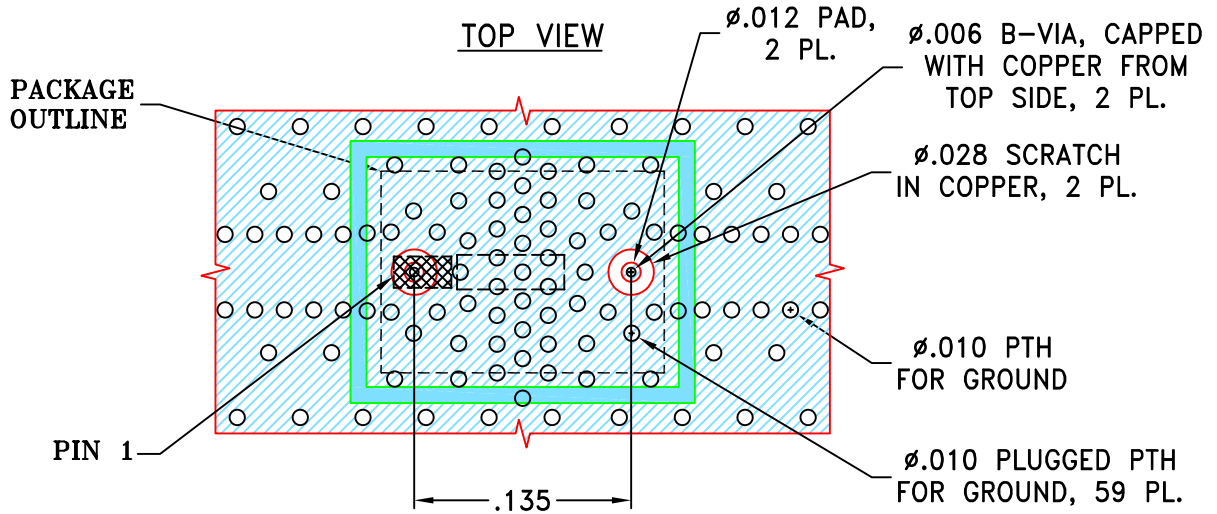
THIRD ANGLE PROJECTION



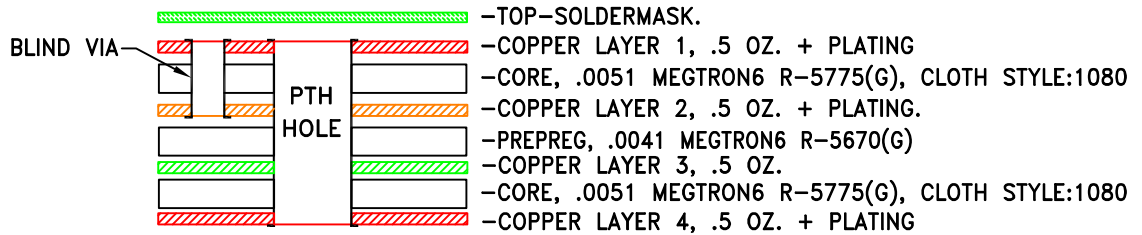
REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-013254	NEW RELEASE	05/16/22	ITG	IL
A	ECO-015587	UPDATED STACK-UP DIAGRAM	11/01/22	ITG	IL
B	ECO-020890	ADDED DIMENSIONS	02/16/24	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR
NM1812C-3 CASE STYLE



STACK-UP DIAGRAM



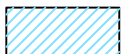
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- COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
	DRAWN	ITG	05/16/22
	CHECKED	GF	05/16/22
	APPROVED	IL	05/16/22

DIMENSIONS ARE IN INCHES
TOLERANCES ON:
2 PL DECIMALS ±
3 PL DECIMALS ± .005
ANGLES ±
FRACTIONS ±



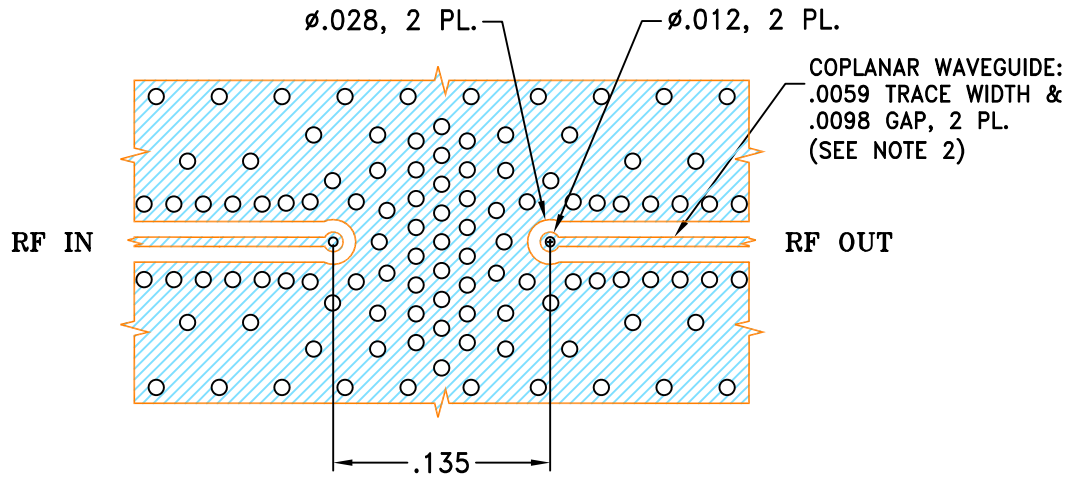
Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

PL, NM1812C-3, TB-1239

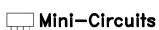
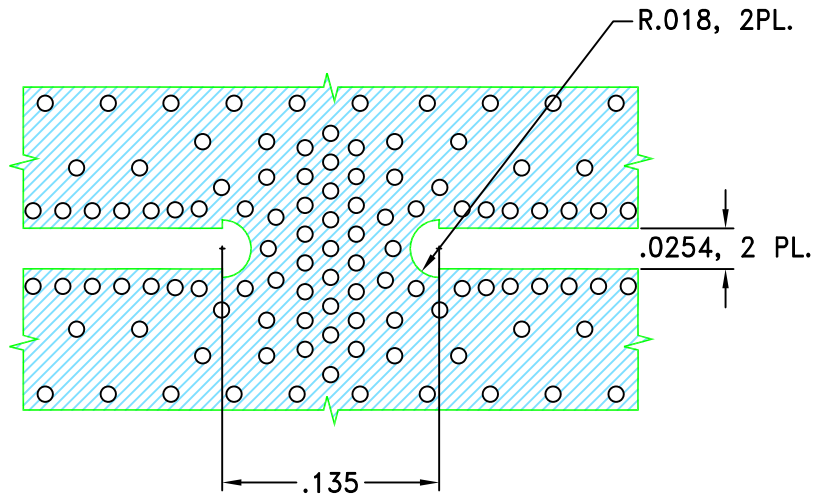
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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B
FILE:	98PL730	SCALE: 8:1	SHEET: 1 OF 2

LAYER 2, B-VIA & PTH



LAYER 3 & PTH

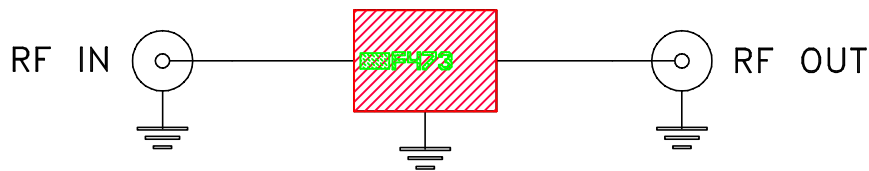
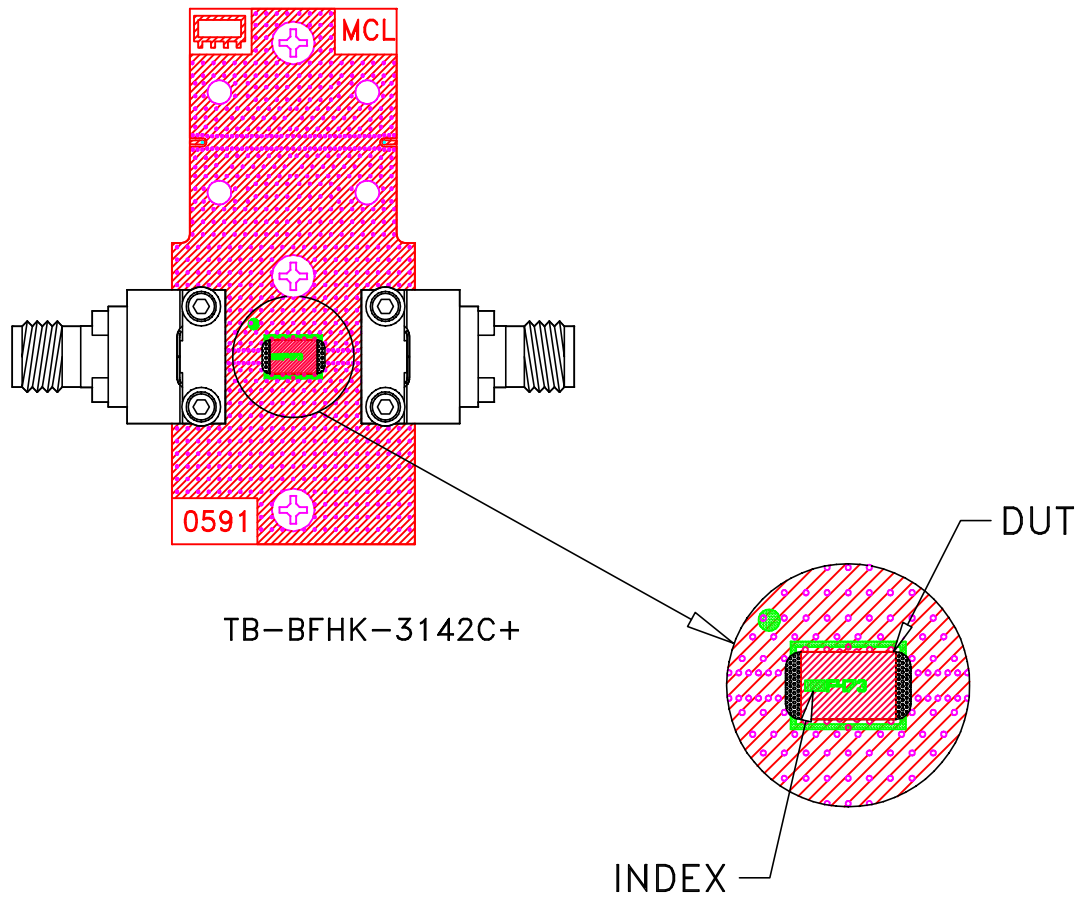


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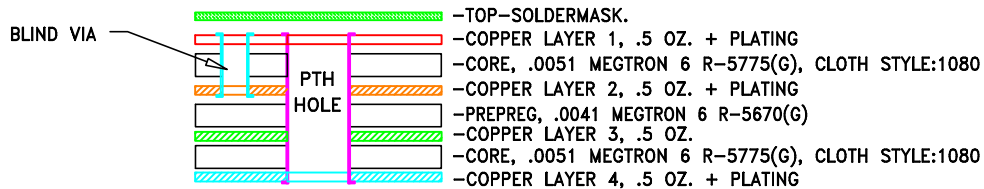
ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-730	REV: B
FILE: 98PL730	SCALE: 8:1	SHEET: 2 OF 2	

Evaluation Board and Circuit




Schematic Diagram



STACK-UP DIAGRAM

Notes:

1. 1.85 mm Female End Launch Connector.
2. PCB Material: Megtron 6 R5775(N).
Dielectric Constant=3.6.
3. Total finished thickness .023".

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	